

Technical Data Sheet

Chip LEDs with Right Angle Lens

22-21UYC/S530-XX/TR8

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS complaint Version.



- The 22-21 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.
- Indoor signboard use.

Device Selection Guide

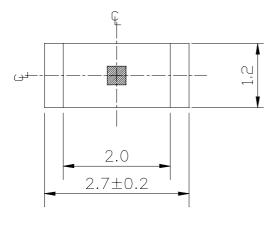
D. AN		T (1)	
Part No.	Material	Emitted Color	Lens Color
22-21UYC/S530-XX/TR8	AlGaInP	Brilliant Yellow	Water Clear

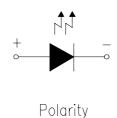


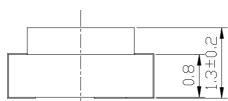
Page: 1 of 9

Rev.1

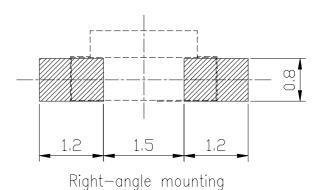
Package Outline Dimensions

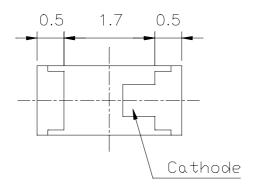






For Reflow Soldering (propose)





Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm



EVERLIGHT ELECTRONICS CO.,LTD.

22-21UYC/S530-XX/TR8

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V_R	5	V	
Forward Current	IF	25	mA	
Operating Temperature	Topr	-40 ~ +85	${\mathbb C}$	
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\!\mathbb{C}$	
Electrostatic Discharge(HBM)	ESD	2000	V	
Power Dissipation	Pd	60	mW	
Peak Forward Current (Duty 1/10 @1KHz)	IF	60	mA	
Soldering Temperature	Tsol	Reflow Soldering: 260 °C for 10 sec. Hand Soldering: 350 °C for 3 sec.		

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	*Chip Rank	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	A2	16	40			
		A3	37	58			IF=20mA
		A4	53	80		mcd	
		A5	64	101			
		A6	80	117			
Viewing Angle	2 \theta 1/2			130		deg	IF=20mA
Peak Wavelength	λр			591		nm	IF=20mA
Dominant Wavelength	λd			589		nm	IF=20mA
Spectrum Radiation Bandwidth	Δλ			15		nm	IF=20mA
Forward Voltage	VF		1.7	2.0	2.4	V	IF=20mA
Reverse Current	Ir				10	μ A	V _R =5V

*22-21UYOC/S530<u>-XX/</u>TR8

____∖ Chip Rank

Everlight Electronics Co., Ltd.

http://www.everlight.com

Rev.1

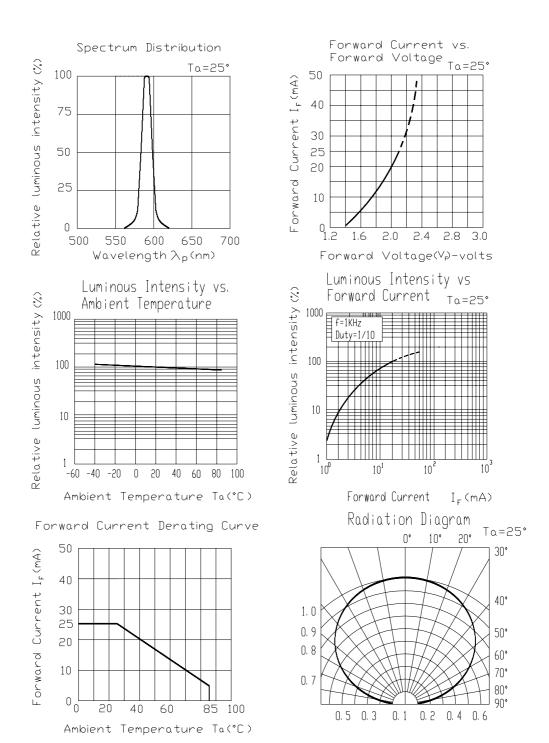
Page: 3 of 9

Device No:SZDSE-221-004

Prepared date:19-Aug-2005

Prepared by:Wang Zhiyong

Typical Electro-Optical Characteristics Curves



Prepared by: Wang Zhiyong

Label explanation

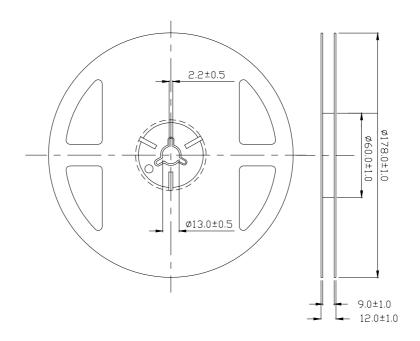
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank

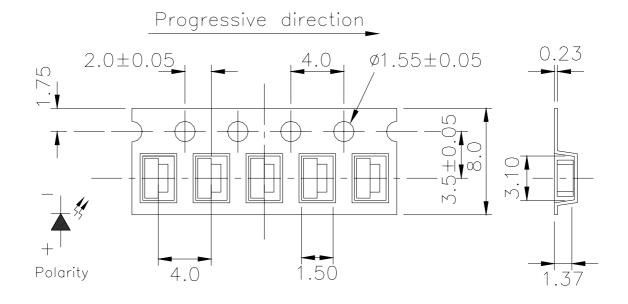


Reel Dimensions



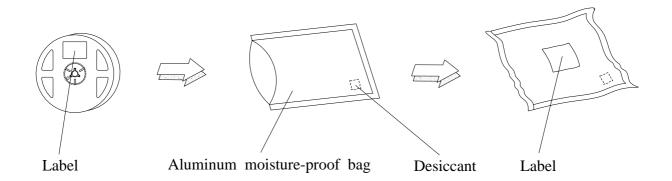
Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging



Everlight Electronics Co., Ltd. Device No:SZDSE-221-004

http://www.everlight.com Prepared date:19-Aug-2005 Rev.1

Page: 6 of 9

Prepared by: Wang Zhiyong



Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90 %

LTPD: 10 %

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow	Temp. : 240°C±5°C Min. 5 sec.	6 min.	22 Pcs.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min. \int 5 min. $L: -40^{\circ}\mathbb{C}$ 15min.	300 Cycles	22 Pcs.	0/1
3	Thermal Shock	H:+100°C 5min. ∫ 10 sec. L:-10°C 5min.	300 Cycles	22 Pcs.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 Pcs.	0/1
5	Low Temperature Storage	Temp. : -55°℃	1000 Hrs.	22 Pcs.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 Pcs.	0/1
7	High Temperature / High Humidity	85°C/R.H85%	1000 Hrs.	22 Pcs.	0/1

Rev.1

http://www.everlight.com

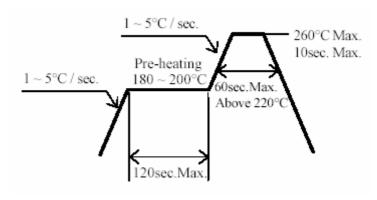
Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at 30°C or less and 60% RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
- 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

 Baking treatment: 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

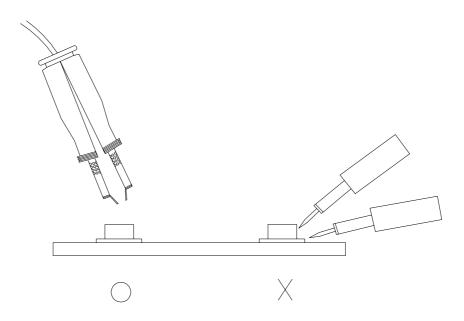


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.

Office: No 25, Lane 76, Sec 3, Chung Yang Rd, Tucheng, Taipei 236, Taiwan, R.O.C Tel: 886-2-2267-2000, 2267-9936

Fax: 886-2267-6244, 2267-6189, 2267-6306

http://www.everlight.com